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MICRO	STANDARD MICROCIRCUIT DRAWING			]	CKED Larry S								COL	UMBI	JS, O	HIO	43216	3		
THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS			APPROVED BY Raymond Monnin				MICROCIRCUIT, DIGITAL, BIPOLAR, SYNCHRONOUS 4-BIT COUNTER, MONOLITHIC SILICON													
AND AGENCIES OF THE DEPARTMENT OF DEFENSE			DRAWING APPROVAL DATE 97-05-30																	
AMSC N/A				REV	ISION	LEVEL	•				ZE A ET	CA	GE CC 67268	<u> </u>			5962·	-9754	18	
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DSCC FORM 2233

APR 97

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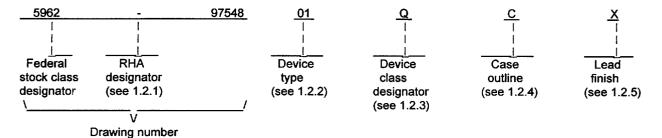
<u>DISTRIBUTION STATEMENT A</u>. Approved for public release; distribution is unlimited.

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#### 1. SCOPE

询"5962-9754801QEA"供应商 1 <u>Scope</u>. This drawing documents two product assurance class levels consisting of high reliability (device classes Q and M) and space application (device class V). A choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of Radiation Hardness Assurance (RHA) levels are reflected in the

1.2 PIN. The PIN is as shown in the following example:



- 1.2.1 RHA designator. Device classes Q and V RHA marked devices meet the MIL-PRF-38535 specified RHA levels and are marked with the appropriate RHA designator. Device class M RHA marked devices meet the MIL-PRF-38535, appendix A specified RHA levels and are marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.
  - 1.2.2 <u>Device type(s)</u>. The device type(s) identify the circuit function as follows:

Device type	Generic number	Circuit function
01	54163	Synchronous 4-bit counter

1.2.3 Device class designator. The device class designator is a single letter identifying the product assurance level as follows:

Device class	Device requirements documentation
<b>M</b>	Vendor self-certification to the requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A
Q or V	Certification and qualification to MIL-PRF-38535

1.2.4 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	<u>Terminals</u>	Package style
E	GDIP1-T16 or CDIP2-T16	16	duai-in-line
F	GDFP2-F16 or CDFP3-F16	16	flat pack
2	CQCC1-N20	20	leadless square chip carrier

1.2.5 Lead finish. The lead finish is as specified in MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 2

DSCC FORM 2234 **APR 97** 

**■ 9004708 0028934 157 ■** 

1.3 Absolute maximum ratings. 1/

查询<sup>"</sup>5962-9754801QEA"供应商 <del>Supply voltage range (V<sub>CC</sub>).......</del> -0.5 V dc to +7.0 V dc Input voltage (VIN).....-0.5 V dc to +5.5 V dc Interemitter voltage 2/ ...... 5.5 V Operating free air temperature range ...... -55 °C to +125 °C Maximum power dissipation (PD) ...... 500 mW Storage temperature range -65 °C to +150 °C Thermal resistance, junction-to-case ( $\theta$ JC) ...... See MIL-STD-1835

Junction temperature (T<sub>J</sub>)...... +175 °C

1.4 Recommended operating conditions.

High-level output current (IOH).....--800 μA max Low-level output current (IOL) ...... 16 mA max Setup time, t<sub>SU</sub>, from data inputs A, B, C, D to CLK input 3/ ..... 20 ns min Setup time, t<sub>SU</sub>, from ENP to CLK input 3/...... 20 ns min Hold time at any input, th...... 0 ns min Operating free-air temperature range (T<sub>A</sub>) ...... -55 °C to +125 °C

1.5 Digital logic testing for device classes Q and V.

Fault coverage measurement of manufacturing 

#### 2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

### **SPECIFICATION**

### **MILITARY**

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

Values will be added when they become available.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 3

DSCC FORM 2234 **APR 97** 

**-** 9004708 0028935 093 **-**

Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.

This is the voltage between two emitters of a multiple-emitter transistor.

The waveforms on t<sub>su</sub> are on figure 2.

### **STANDARDS**

# 查询"<u>5962</u>-9754801QEA"供应商

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

MIL-STD-973 - Configuration Management. MIL-STD-1835 - Microcircuit Case Outlines.

**HANDBOOKS** 

**MILITARY** 

MIL-HDBK-103 - List of Standard Microcircuit Drawings (SMD's).

MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

#### 3. REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements for device classes Q and V shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. The individual item requirements for device class M shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein for device classes Q and V or MIL-PRF-38535, appendix A and herein for device class M.
  - 3.2.1 Case outline. The case outline shall be in accordance with 1.2.4 herein .
  - 3.2.2 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 1.
  - 3.2.3 Switching waveforms and test circuit. The switching waveforms and test circuit shall be as specified on figure 2.
- 3.3 <u>Electrical performance characteristics and postirradiation parameter limits</u>. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the full case operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are defined in table I.
- 3.5 <u>Marking</u>. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-HDBK-103. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device. For RHA product using this option, the RHA designator shall still be marked. Marking for device classes Q and V shall be in accordance with MIL-PRF-38535. Marking for device class M shall be in accordance with MIL-PRF-38535, appendix A.
- 3.5.1 <u>Certification/compliance mark</u>. The certification mark for device classes Q and V shall be a "QML" or "Q" as required in MIL-PRF-38535. The compliance mark for device class M shall be a "C" as required in MIL-PRF-38535, appendix A.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 4

DSCC FORM 2234 APR 97

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- 3.6 Certificate of compliance, For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.6.1 herein). For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6.2 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device classes Q and V, the requirements of MIL-PRF-38535 and herein or for device class M, the requirements of MIL-PRF-38535, appendix A and herein.
- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required for device classes Q and V in MIL-PRF-38535 or for device class M in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 <u>Notification of change for device class M</u>. For device class M, notification to DSCC-VA of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change as defined in MIL-STD-973.
- 3.9 <u>Verification and review for device class M.</u> For device class M, DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
- 3.10 <u>Microcircuit group assignment for device class M</u>. Device class M devices covered by this drawing shall be in microcircuit group number 5 (see MIL-PRF-38535, appendix A).
  - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. For device class M, sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.
- 4.2 <u>Screening</u>. For device classes Q and V, screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection.
  - 4.2.1 Additional criteria for device class M.
    - a. Burn-in test, method 1015 of MIL-STD-883.
      - (1) Test condition A, B, C or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.
      - (2)  $T_A = +125$  °C, minimum.
    - b. Interim and final electrical test parameters shall be as specified in table II herein.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 5

DSCC FORM 2234 APR 97

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# 查询"5962-9754801QEA"供应商ABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55 °C ≤ T <sub>C</sub> ≤ +125°C unless otherwise specified		Group A subgroups	Limits		Unit
					Min	Max	
High-level input voltage	VIH			1, 2, 3	2		V
Low-level input voltage	VIL			1, 2, 3		0.8	V
Input clamp voltage	ViK	V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -12 mA		1, 2, 3		-1.5	V
High level output voltage	Voн	V <sub>CC</sub> = 4.5 V, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = -800 μA		1, 2, 3	2.4		V
Low-level output voltage	VOL	V <sub>CC</sub> = 4.5 V, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 16 mA		1, 2, 3		0.4	٧
Input current at maximum input voltage	lį	V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = 5.5 V		1, 2, 3		1	mA
High-level input current	lін	V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = 2.4 V	CLK or ENT	1, 2, 3		80	μΑ
			Other inputs	1, 2, 3		40	
Low-level input current	I <sub>I</sub> L	V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = 0.4 V	CLK or ENT	1, 2, 3		-3.2	mA
			Other inputs	1, 2, 3		-1.6	
Short-circuit output current	los <u>1</u> /	V <sub>CC</sub> = 5.5 V		1, 2, 3	-20	-57	mA
Supply current, all outputs high	<sup>1</sup> ССН <u>2</u> /	V <sub>CC</sub> = 5.5 V		1, 2, 3		85	mA
Supply current, all outputs	ICCL	V <sub>CC</sub> = 5.5 V		1, 2, 3		91	mA
Functional test	<u>3/</u> <u>4</u> /	V <sub>IN</sub> = V <sub>IH</sub> Min or V <sub>IL</sub> Max Verify output V <sub>O</sub> , See 4.4.	lb	7, 8			

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 6

DSCC FORM 2234 APR 97

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TABLE I. <u>Electrical performance characteristics</u> .								
查询:"5962-9754801QEA"供应商		Conditions -55 °C ≤ T <sub>C</sub> ≤ +125°C unless otherwise specified	Group A subgroups	Limits		Unit		
				Min	Max			
Maximum clock frequency	fmax	$C_L = 15 \text{ pF}, R_L = 400 \Omega,$	9	25		MHz		
Propagation delay time	tPLH	See figure 4 <u>5</u> /	9		35	ns		
from CLK to RCO	tPHL		9		35	ns		
Propagation delay time	tPLH	]	9		20	ns		
from CLK(LOAD input	tPHL		9		23	ns		
high) to any Q					<u> </u>			
Propagation delay time	tPLH		9	<u> </u>	25	ns		
from CLK(LOAD input	t <sub>PHL</sub>		9		29	ns		
low) to any Q								
Propagation delay time	tPLH		9		16	ns		
from ENT to RCO	t <sub>PHL</sub>		9		16	ns		
Propagation delay time	tPHL		9		38	ns		
from CLR to any Q				1	İ	1		

- 1/ Not more than one output should be shorted at a time.
- 2/ ICCH is measured with the load input high, then again with the load input low, with all other inputs high and all outputs open.
- 3/ ICCL is measure with the clock input high, then again with the clock input low, with all other inputs low and all outputs open.
- 4/ Tests shall be performed in sequence, attributes data only. Functional tests shall include the truth table and other logic patterns used for fault detection. The test vectors used to verify the truth table shall, at a minimum, test all functions of each input and output. All possible input to output logic patterns per function shall be guaranteed, if not tested, to the truth table in figure 2 herein. Functional tests shall be performed in sequence as approved by the qualifying activity on qualified devices. Allowable tolerances per MIL-STD-883 may be incorporated. For outputs, L ≤ 0.8 V, H ≥ 2.0 V.
- 5/ Propagation delay for clearing is measured from the clock input transition.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 7

DSCC FORM 2234 APR 97

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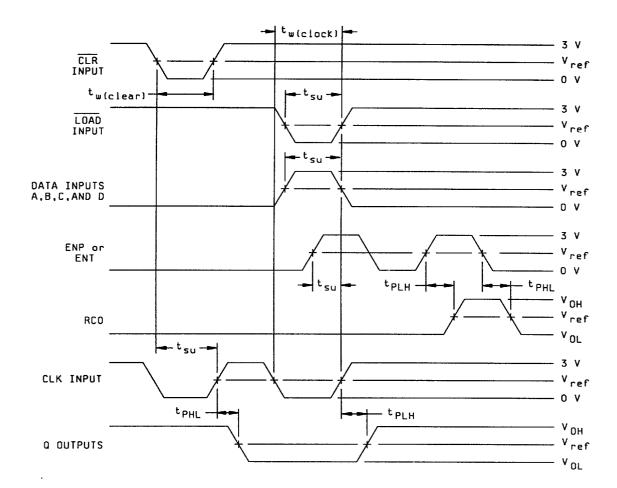
QEA 供应图			
Device type	01		
Case outlines	E, F	2	
Terminal	Terminal symbol		
number			
1	CLR	NC	
2	CLK	CLR	
3	Α	CLK	
4	В	Α	
5	С	3	
6	D	NC	
7	ENP	С	
8	GND	D	
9	LOAD	ENP	
10	ENT	GND	
11	QD	NC	
12	Qc	LOAD	
13	QB	ENT	
14	Q <sub>A</sub> RCO	QD	
15	RCO	QC	
16	Vcc	NC	
17		QB	
18		QA	
19		Q <sub>A</sub> RCO	
20		VCC	

FIGURE 1. <u>Terminal connections</u>.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 8

DSCC FORM 2234 APR 97

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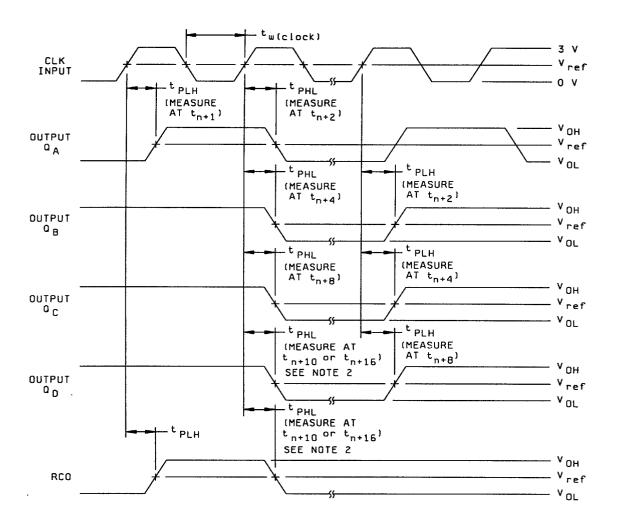
#### NOTES:

- 1. The input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1MHz, duty cycle  $\leq$  50%,  $Z_{out} \cong$  50  $\Omega$ ,  $t_r \leq$  10 ns,  $t_f \leq$  10 ns.
- 2. Enable P and enable T setup times are measured at  $t_{n+0}$ .
- 3.  $V_{ref} = 1.5 V$

FIGURE 2. Test circuit and switching waveforms.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 9

DSCC FORM 2234 APR 97 ■ 9004708 0028941 397



### NOTES:

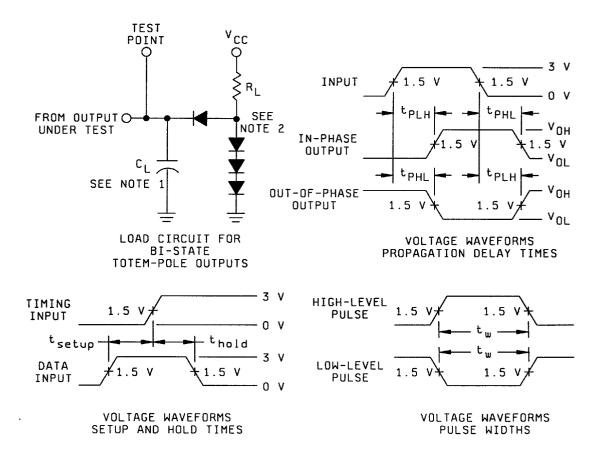
- The input pulses are supplied by a generator having the following characteristics: PRR ≤ 1 MHz, duty cycle ≤ 50%, Z<sub>Out</sub> ≅ 50 Ω, t<sub>r</sub> ≤ 10 ns, t<sub>f</sub> ≤ 10 ns. Vary PRR to measure f<sub>max</sub>.
- 2. Outputs Q<sub>D</sub> and carry are tested at  $t_n + 16$ , where  $t_n$  is the bit time when all outputs are low.
- 3.  $V_{ref} = 1.5 V$

FIGURE 2. Test circuit and switching waveforms - Continued.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 10

DSCC FORM 2234 APR 97

**9004708 0028942 223** 



### NOTES:

- 1. CL includes probe and jig capacitance. CL = 15 pF, RL = 400  $\Omega$ .
- 2. All diodes are 1N3064 or equivalent.

FIGURE 2. Test circuit and switching waveforms - Continued.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET <b>11</b>

DSCC FORM 2234 APR 97

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- a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
- b. Interim and final electrical test parameters shall be as specified in table II herein.
- Additional screening for device class V beyond the requirements of device class Q shall be as specified in MIL-PRF-38535, appendix B.
- 4.3 Qualification inspection for device classes Q and V. Qualification inspection for device classes Q and V shall be in accordance with MIL-PRF-38535. Inspections to be performed shall be those specified in MIL-PRF-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).
- 4.4 Conformance inspection. Technology conformance inspection for classes Q and V shall be in accordance with MIL-PRF-38535 including groups A, B, C, D, and E inspections and as specified herein except where option 2 of MIL-PRF-38535 permits alternate in-line control testing. Quality conformance inspection for device class M shall be in accordance with MIL-PRF-38535, appendix A and as specified herein. Inspections to be performed for device class M shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

#### 4.4.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. For device class M, subgroups 7 and 8 tests shall be sufficient to verify the truth table. For device classes Q and V, subgroups 7 and 8 shall include verifying the functionality of the device; these tests shall have been fault graded in accordance with MIL-STD-883, test method 5012 (see 1.5 herein).
- c. Subgroups 4, 5, and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- 4.4.2 Group C inspection. The group C inspection end-point electrical parameters shall be as specified in table II herein.
- 4.4.2.1 Additional criteria for device class M. Steady-state life test conditions, method 1005 of MIL-STD-883:
  - a. Test condition A, B, C or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
  - b. TA = +125 °C, minimum.
  - c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 12

DSCC FORM 2234 APR 97

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TABLE II. <u>Electrical test requirements</u>.

Test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)	Subgroups (in accordance of MIL-PRF-38535	
	Device class M	Device class Q	Device class V
Interim electrical parameters (see 4.2)			
Final electrical parameters (see 4.2)	<u>1</u> / 1, 2, 3, 7, 8, 9	<u>1</u> / 1, 2, 3, 7, 8, 9	<u>2</u> / 1, 2, 3, 7, 8, 9
Group A test requirements (see 4.4)	1, 2, 3, 7, 8, 9	1, 2, 3, 7, 8, 9	1, 2, 3, 7, 8, 9
Group C end-point electrical parameters (see 4.4)	1, 2, 3	1, 2, 3	1, 2, 3, 7, 8, 9
Group D end-point electrical parameters (see 4.4)	1, 2, 3	1, 2, 3	1, 2, 3
Group E end-point electrical parameters (see 4.4)	1, 7, 9	1, 7, 9	1, 7, 9

- 1/ PDA applies to subgroup 1.
- 2/ PDA applies to subgroups 1 and 7.
- 4.4.2.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
  - 4.4.3 Group D inspection. The group D inspection end-point electrical parameters shall be as specified in table II herein.
- 4.4.4 <u>Group E inspection</u>. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein).
  - a. End-point electrical parameters shall be as specified in table II herein.
  - b. For device classes Q and V, the devices or test vehicle shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535 for the RHA level being tested. For device class M, the devices shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535, appendix A for the RHA level being tested. All device classes must meet the postirradiation end-point electrical parameter limits as defined in table I at T<sub>A</sub> = +25 °C ± 5 °C after exposure, to the subgroups specified in table II herein.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET 13

DSCC FORM 2234 APR 97 ■ 9004708 0028945 T32 ■

c, When specified in the purchase order or contract, a copy of the RHA delta limits shall be supplied. 查询"5962-9754801QEA"供应商

- 5. PACKAGING
- 5.1 <u>Packaging requirements</u>. The requirements for packaging shall be in accordance with MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.
  - 6. NOTES
- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.1.1 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
  - 6.1.2 Substitutability. Device class Q devices will replace device class M devices.
- 6.2 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-973 using DD Form 1692, Engineering Change Proposal.
- 6.3 <u>Record of users</u>. Military and industrial users should inform Defense Supply Center Columbus when a system application requires configuration control and which SMD's are applicable to that system. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0525.
- 6.4 <u>Comments</u>. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43216-5000, or telephone (614) 692-0674.
- 6.5 <u>Abbreviations, symbols, and definitions</u>. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535 and MIL-HDBK-1331.
  - 6.6 Sources of supply.
- 6.6.1 <u>Sources of supply for device classes Q and V</u>. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DSCC-VA and have agreed to this drawing.
- 6.6.2 <u>Approved sources of supply for device class M.</u> Approved sources of supply for class M are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

STANDARD MICROCIRCUIT DRAWING	SIZE <b>A</b>		5962-97548
DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000		REVISION LEVEL	SHEET <b>14</b>

DSCC FORM 2234 APR 97 9004708 0028946 979

# 查询"5962-9754801QEA"供应**智**ANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 97-05-30

Approved sources of supply for SMD 5962-97548 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535.

Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-9754801QEA	01295	SNJ54163J
5962-9754801QFA	01295	SNJ54163W
5962-9754801Q2A	<u>3</u> /	

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. The device manufacturers listed herein are authorized to supply alternate lead finishes "A", "B", or "C" at their discretion. Contact the listed approved source of supply for further information.
- 2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.
- 3/ This device is not available from an approved source of supply.

Vendor CAGE number

Vendor name and address

01295

Texas Instruments Incorporated 13500 N. Central Expressway P.O. Box 655303 Dallas, TX 75265 Point of contact:

> I-20 at FM 1788 Midland, TX 79711-0448

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.

**■ 9004708 0028947 805 ■**